

Application Data Sheet

Application Information

Application Type::	National Phase
Subject Matter::	Utility
CD-ROM or CD-R:	None
Title::	METHOD FOR MANUFACTURING SEMICONDUCTOR WAFER, METHOD FOR RECEIVING ORDER FOR MANUFACTURE OF SEMICONDUCTOR WAFER, AND SYSTEM FOR RECEIVING ORDER FOR MANUFACTURE OF SEMICONDUCTOR WAFER
Attorney Docket Number::	120503
Total Drawing Sheets::	6
Small Entity::	No

Applicant Information

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Tatsuo
Family Name::	ITO
City of Residence::	Tokyo
Country of Residence::	Japan

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Shigeyoshi
Family Name::	NETSU
City of Residence::	Fukushima
Country of Residence::	Japan

Applicant Authority type::	Inventor
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Primary Citizenship Country:: Japan
 Status:: Full Capacity
 Given Name:: Masashi
 Family Name:: ICHIKAWA
 City of Residence:: Fukushima
 Country of Residence:: Japan

Applicant Authority type:: Inventor
 Primary Citizenship Country:: Japan
 Status:: Full Capacity
 Given Name:: Nobuhiro
 Family Name:: OHARA
 City of Residence:: Fukushima
 Country of Residence:: Japan

Correspondence Information

Correspondence Customer Number:: 25944

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/00557	01/22/2003

Foreign Priority Information			
Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-19334	01/29/2002	Yes

Assignee Information	
Assignee Name::	SHIN-ETSU HANDOTAI CO., LTD.
Street of mailing address::	4-2, Marunouchi 1-chome, Chiyoda-ku
City of mailing address::	Tokyo
Country of mailing address::	Japan